

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	Wolfgang Hetzel et al.	Examiner:
Serial No.:	10/577,173	Group Art Unit:
Filed:	April 26, 2006	Docket: 1441.141.101
Title:	SEMICONDUCTOR DEVICE WITH PLASTIC PACKAGE MOLDING COMPOUND, SEMICONDUCTOR CHIP AND LEADFRAME AND METHOD FOR PRODUCING SAME	

RESPONSE TO THE NOTIFICATION OF DEFECTIVE RESPONSE

Mail Stop Missing Parts

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

In response to the "Notification of Defective Response" (see enclosed copy), the previously filed executed Declaration, Power of Attorney is enclosed. The Transmittal filed April 26, 2006 had the International Application No. (PCT/DE2004/0023749) incorrect. The **Declaration enclosed has the correct International Application No. (PCT/DE2004/002374).**

No fees are required, however, if such fees are required, the Patent Office is hereby authorized to charge Deposit Account No. 50-0471.

Applicants assume the application is now in proper order and in condition for examination. Please direct any inquiries to the undersigned attorney at (612) 767-2503.

Respectfully submitted,

Wolfgang Hetzel et al.,

By their attorneys,

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